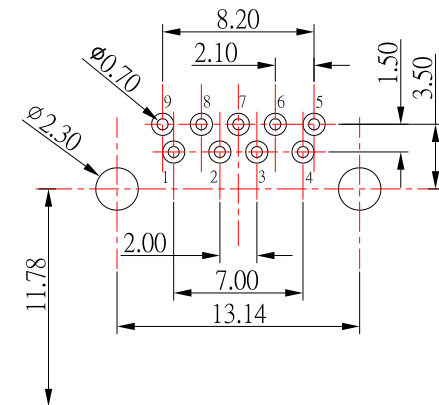
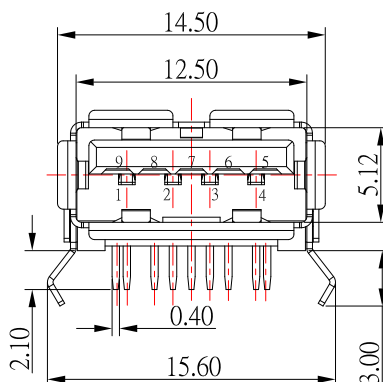
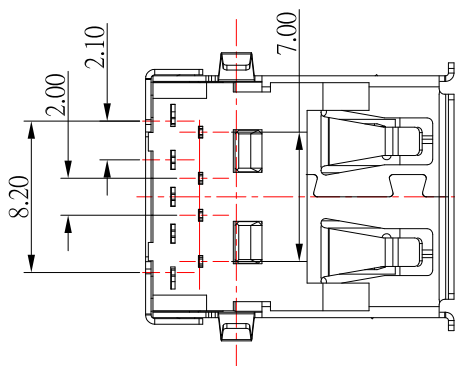
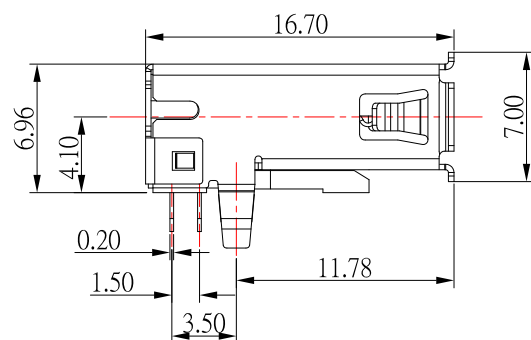
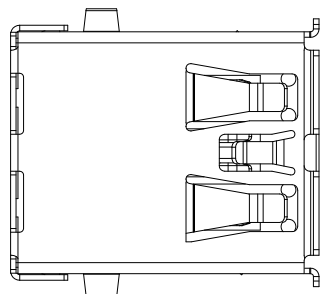




SUA-110H-30x-S277

鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"



RECOMMENDED PCBA LAYOUT

SPECIFICATIONS:

1.ELECTRICAL CHARACTERISTICS;

- 1.1 CONTACT CURRENT RATING: 1.5 A
- 1.1 CONTACT RESISTANCE: 30mΩ MAX
- 1.2 DIELECTRIC WITHSTANDING VOLTAGE: 100 V
- 1.3 INSULATION RESISTANCE: 100 MΩ MIN
- 1.4 OPERATING TEMPERATURE: -40°C ~ 85°C

2.MATERIAL:

- 2.1 HOUSING: LCP
- 2.2 CONTACT: PHOSPHOR BRONZE
- 2.3 SHELL: BRASS

3.PLATING:

- 3.1 CONTACT: PLATED GOLD IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
- 3.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER

Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdA_SSRX-
6	StdA_SSRX+
7	GND_DRAIN
8	StdA_SSTX-
9	StdA_SSTX+
Shell	Shield



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CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE
10/26/23
10/26/23
10/26/23

MATL
FINISH
SCALE

1 : 1

TITLE
MODLE
DWG NO.

CONNECTOR
USB AF 3.0 90度DIP 彎腳
SUA-110H-30x-S277

SIZE
A4
VER
R4

ITEM NO	DESCRIPTION	DRAWN	DATE
4	更新HOUSING材質	Jack	102623
3	更新為A0版	Jack	081318
2	新增PIN定義	Jack	041717
1	更新圖面	Jack	033115